EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L6	12	("5185294" "5324673" "5614764" "5904560" "5909635" "6010933" "6077775" "6080663" "6191029" "6287961" "6297147" "6566262").PN. OR ("7300871").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2009/01/26 21:42
L7	10	("4720908" "5341026" "5470792" "5759915" "5891804" "6130157" "6174810" "6326301" "6362526" "6376377").PN. OR ("7279790").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2009/01/26 21:43
L10	10	("20030080761" "5581475" "5963729" "6010962" "6532570" "6578178" "6603321" "6634013").PN. OR ("6816995").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2009/01/26 21:56
L14	160	257/E21.584	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/26 22:09
L15	58	257/E21.582	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/26 22:09

L16	36	257/E21.174	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/26 22:10
L17	3661	257/751	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/26 22:11
L18	7646	257/758	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/26 22:13
L19	2208	257/762	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/26 22:27
L20	1638	257/763	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/01/26 22:41
S1	244	(dual or double) with (semiconductor or die or dice or chip or IC) with (two or multi\$3) with (resin or cover\$3 or mold\$3 or encapsulat\$3)	USPAT	OR	ON	2007/11/26 15:14
S2	16	("5034350" "5366933" "5646829" "5733802" "5898220").PN. OR ("6133067").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/26 15:23

S3	47	("20010006252" "20020142513" "20030047798" "4264917" "4729061" "4850105" "5036024" "5172303" "5219795" "5239198" "5273938" "5291062" "5376588" "5383269" "5795799" "5798564" "5815372" "5843808" "5963429" "5993864" "5998864" "6022759" "6023098" "6117704"	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/26 15:24
		"6133067" "6133629" "6153928" "6157080" "6181002" "6184463" "6201302" "6214641" "6239496" "6256206" "6291892" "6329713" "6333566" "6344687" "6365963" "6469376" "6472732" "6515356" "6798049").PN. OR ("6916682").URPN.				
S4	64	("5034350" "5082802" "5202288" "5227338" "5273938").PN. OR ("5366933").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/26 15:26

S5	170	(semiconductor or die or dice or chip or IC) same damasc\$4 and ("Cu" or copper) and (via or plug or open\$3 or hole) with (additiv \$3 or impurity)	USPAT	OR	ON	2007/11/27 18:20
S6	490	(semiconductor or die or dice or chip or IC) same damasc\$4 and ("Cu" or copper) and (via or plug or open\$3 or hole) with (alloy with ("Cu" or copper))	USPAT	OR	ON	2007/11/27 17:09
S7	483	(semiconductor or die or dice or chip or IC) same damasc\$4 and ("Cu" or copper) with (metal\$4 or wiring or interconnect\$3) and (via or plug or open\$3 or hole) with (alloy with ("Cu" or copper))	USPAT	OR	ON	2007/11/27 19:25
S8	457	S7 not S5	USPAT	OR	ON	2007/11/27 17:10
S 9	404	(semiconductor or die or dice or chip or IC) same damasc\$4 and ("Cu" or copper) with (metal\$4 or wiring or interconnect\$3) and (via or plug or hole) with (alloy with ("Cu" or copper))	USPAT	OR	ON	2007/11/27 17:14
S 10	288	(semiconductor or die or dice or chip or IC) same damasc\$4 and ("Cu" or copper) with (metal\$4 or wiring or interconnect\$3) and (via or plug or hole) with (alloy near ("Cu" or copper))	USPAT	OR	ON	2007/11/27 17:14

S11	10	("4720908" "5341026" "5470792" "5759915" "5891804" "6130157" "6174810" "6326301" "6362526" "6376377").PN. OR ("7279790").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 17:53
S12	48	("4556897").PN. OR ("5341026").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 17:55
S13	17	("20020130046" "20030140988" "20040072423" "20050095847" "5948467" "6022808" "6077780" "6221765" "6225670" "6350364" "63508840" "6358840" "6391777" "6451682" "6582569" "7030016").PN. OR ("7189650").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 18:12
S14	8	("5356836" "5607718" "5661345" "5851365" "6207222").PN. OR ("6720253").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 18:09
S15	79	("4920072" "4920073" "4938996" "4960732" "4985750" "4994410" "5010032" "5081064" "5091339" "5250465" "5292558" "5354712" "5439731" "5480836" "5521119"	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 18:13

		"5585673" "5595937" "5693563" "5739579" "5814557" "5824599" "5858873" "5872053" "5895266" "5930669" "5933753" "5960310" "6001736").PN. OR ("6207222").URPN.				
S16	296	(semiconductor or die or dice or chip or IC) same damasc\$4 and ("Cu" or copper) and (via or plug or open\$3 or hole) with (dop\$3)	USPAT	MOR	ON	2007/11/27 18:20
S17	6	("5966605" "6156654" "6365446").PN. OR ("6731006").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 18:55
S18	9	("5185294" "5614764" "5904560" "5909635" "6077775" "6191029" "6221747" "6297147" "6566262").PN. OR ("68333321").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 18:54
S19	7	("5470794" "5620926" "5909048" "5998255" "6096391").PN. OR ("6221747").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 19:02

S20	22	("3863334" "4223336" "4837176" "5028557" "5213989" "5358901" "5360995" "5382540" "5633199" "5674787" "5879630" "5939788" "6150214" "6228759" "6541695" "6541695" "6642623" "6703307" "6706629" "6713875" "6731006").PN. OR ("7115502").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27
S21	22	("3863334" "4223336" "4837176" "5028557" "5213989" "5358901" "5360995" "5382540" "5633199" "5674787" "5879630" "5939788" "6150214" "6228759" "6541695" "6642623" "6703307" "6706629" "6713875" "6731006").PN. OR ("6861758").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27
S22	16	("6022808" "6057223" "6096648" "6117770" "6268291").PN. OR ("6500749").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 19:18

S23	51	("4461672" "4673592" "4795722" "4996133" "5071714" "5087591" "5171642" "5202579" "5212352" "5966865").PN. OR ("5360995").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 19:19
S24	41	("4619038" "4698244" "5225372").PN. OR ("5358901").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 19:05
\$25	31	("4410622" "4710398" "4751198" "4910580" "4917759" "4924295" "4937652" "4962414" "4985750" "4987562" "5008730" "5049975" "5051812" "5070392" "5081064" "5200359" "5231053" "5312775" "5313101" "5356836" "5358901").PN. OR ("5488014").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27
S26	12	("5219789" "5324689" "5360995" "5374849" "5430328" "5523624" "5589713" "5623166").PN. OR ("5672914").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 19:24

S27	484	(semiconductor or die or dice or chip or IC) and damasc\$4 and ("Cu" or copper) with (metal\$4 or wiring or interconnect\$3 or IMD) and (via or plug or open\$3 or hole) with (alloy near ("Cu" or copper))	USPAT	OR	ON	2007/11/27 19:36
\$28	410	(semiconductor or die or dice or chip or IC) and damasc\$4 and ("Cu" or copper) with (metal\$4 or wiring or interconnect\$3 or IMD) and (via or plug or hole) with (alloy near ("Cu" or copper))	USPAT	OR	ON	2007/11/27 21:06
\$29	911	(semiconductor or die or dice or chip or IC) and ("Cu" or copper) with (metal\$4 or wiring or interconnect \$3 or IMD) and (via or plug or hole) with (alloy near ("Cu" or copper))	USPAT	OR	ON	2007/11/27 19:37
S30	501	S29 not S28	USPAT	OR	ON	2007/11/27 20:20
S31	23	("5382817" "5523624" "5600170" "5635763" "5668410" "5883433" "5883434" "5910021" "5914277").PN. OR ("6075293").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 20:37
S 32	417	(semiconductor or die or dice or chip or IC) and damasc\$4 and (via or plug or hole) with (alloy near ("Cu" or copper))	USPAT	OR	ON	2007/11/27 21:19

S 33	1376	(semiconductor or die or dice or chip or IC) and damasc\$4 and (via or plug or hole) with (dop\$3 or embedd \$3 or impurit\$3 or implant\$3)	USPAT	OR	ON	2007/11/27 23:02
S34	1302	S33 not S29	USPAT	OR	ON	2007/11/27 21:20
S35	1297	S34 not S27	USPAT	OR	ON	2007/11/27 21:20
S36	12	("20020076925" "20030203617" "4955688" "4995698" "5221060" "5594829" "5822065" "6023100" "6268291" "6376353" "6387806" "6420262").PN. OR ("7074709").URPN.	US-PGPUB; USPAT; USOCR	OR	OFF	2007/11/27 22:57
S37	1591	(semiconductor or die or dice or chip or IC) and damasc\$4 and (via or plug or hole) with (dop\$3 or embedd \$3 or impurit\$3 or implant\$3)	US-PGPUB	OR	ON	2007/11/28 00:03
S 38	1	(semiconductor or die or dice or chip or IC) and damasc\$4 and (via or plug or hole) with ("Ag" or silver) same dopant with ("Cu" or copper)	USPAT	OR	ON	2007/11/28 00:07
S 39	7	(semiconductor or die or dice or chip or IC) and (via or plug or hole) with ("Ag" or silver) same dopant with ("Cu" or copper)	USPAT	OR	ON	2007/11/28 00:09
S40	20	(semiconductor or die or dice or chip or IC) and (via or plug or hole) with (material or formed) with ("Ag" or silver) and dopant with ("Cu" or copper)	USPAT	OR	ON	2007/11/28 00:16

S41	1	"20020167091"	US-PGPUB	OR	ON	2007/11/28 00:34
S42	1	257/E21.174	US-PGPUB	OR	ON	2007/11/28 00:35
S43	15	257/E21.174	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/28 00:35
S44	18	257/E21.582	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/28 00:35
S45	68	257/E21.584	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/28 00:36
S46	6877	257/758	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/28 01:25
S47	3271	257/751	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/11/28 01:25
S48	24	257/E21.174	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/03 22:21
S49	28	257/E21.582	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/03 22:22

S 50	95	257/E21.584	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/03 22:22
S51	7242	257/758	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/03 22:23
S52	3415	257/751	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/04 13:09
S53	2	"6781241".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2008/06/04 14:01
S56	2071	257/762	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/04 14:59
S 57	1605	257/763	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2008/06/04 16:39

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